

# **LOCTITE® ABLESTIK 2035SC**

January 2024

#### PRODUCT DESCRIPTION

LOCTITE® ABLESTIK 2035SC provides the following product characteristics:

Technology	Proprietary Hybrid Chemistry	
Appearance	Red	
Cure	Heat cure	
Product Benefits	<ul> <li>Non-conductive</li> </ul>	
	<ul> <li>Single component</li> </ul>	
	Fast cure	
	<ul> <li>Low cure temperature</li> </ul>	
	<ul> <li>Low stress</li> </ul>	
Application	Die attach	
pH	3.7	
Filler Type	Silica	

LOCTITE® ABLESTIK 2035SC non-conductive die attach adhesive has been formulated for use in high throughput die attach applications. This material is designed to minimize stress and resulting warpage between dissimilar surfaces.

#### TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	4.2			
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):				
Speed 5 rpm	11,000			
Work Life @ 25°C, hours	24			
Shelf Life @ -40°C (from date of manufacture) days	365			

#### TYPICAL CURING PERFORMANCE

### **Cure Schedule**

90 seconds @ 110°C

# **Alternate Cure Schedule**

60 seconds @ 120°C or 10 seconds @ 150°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

# TYPICAL PROPERTIES OF CURED MATERIAL

# **Physical Properties**

Coefficient of Thermal Expansion :		
Below Tg, ppm/°C	54	
Above Tg, ppm/°C	128	
Glass Transition Temperature, DMTA Tan A Max, °C	120	
Thermal Conductivity, W/(m-K)	0.35	
Extractable Ionic Content, ppm:		
Chloride (CI-)	<30	
Sodium (Na+)	<90	
Potassium (K+)	<20	

Tensile Modulus, DMTA:	
@ -65 °C	N/mm² 3,700 (psi) (540,000)
@ 25 °C	N/mm <sup>2</sup> 2,500 (psi) (360,000)
@ 150 °C	N/mm² 70
@ 250 °C	(psi) (11,000) N/mm² 68 (psi) (10,000)
Water Extract Conductivity, umhos/cm	75
Weight Loss @ 300°C. %	2.51

# TYPICAL PERFORMANCE OF CURED MATERIAL

#### Miscellaneous

Miscellaneous				
Die Shear Strength @ 25 °C				
Die Shear Strength @ 25 °C, 2 X 2 mm die size, kg-f :				
Au die on Au PBGA	11			
Si die on Ag leadframe	13			
Si die on Pd leadframe	12			
Si die on PBGA-FR4	12			
Die Shear Strength vs Temperature, kg-f 3 X 3 mm Si die on PBGA-FR4, kg-f : @ 25°C @ 150°C @ 200°C	25 7.0 4.0			
Chip Warpage @ 25 °C vs Chip Size	0.4			
12.7 x 12.7 mm, 0.38 mm thick Si die, µm	34			

## **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

#### Thawing:

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to -40°C, the adhesive should not be re-frozen.

# **DIRECTIONS FOR USE**

- Thawed adhesive should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- 3. Adhesive must be completely used within the product's recommended work life.



# Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

## Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

#### Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·m x 0.142 = oz·in mPa·s = cP

#### Disclaimer

#### Note:

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